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PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT : WEI, Kung-Hwa et al ATTY DOCKET : BA-22878
SERIAL NO. : 10/828,435
FILED : April 20, 2004
FOR : COVALENTLY BONDED POLYHEDRAL OLIGOMERIC
SILSESQUIOXANE/ POLYIMIDE NANOCOMPOSITES AND
PROCESS FOR SYNTHESIZING THE SAME

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MAILSTOP: AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

S I R :

Supplemental to the Information Disclosure Statement filed June 7, 2004, applicants enclose Form PTO-1449 and a copy of six (6) references discussed in the specification on pages 2 and 4. It is respectfully requested that the foregoing Supplemental Information Disclosure Statement (IDS) be incorporated into the official file of the present patent application. Because this Supplemental IDS is being filed before a first Office Action on the merits, it is believed that no fee is required. However, if a fee should be required for this IDS, the Commissioner for Patents and Trademarks is hereby authorized to charge any required fee, or to credit any overpayment to Deposit Account No. 03-2468.

Respectfully submitted,

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I hereby certify that this document is being deposited with the U.S. Postal Service on June 10, 2004, as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Maria Guastella

FORM PTO-1449 (REV. 7-80)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. : BA-22878		SERIAL NO. 10/828,435	
LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)				APPLICANT: Kung-Hwa WEI ET AL			
				FILING DATE: 4/20/2004		GROUP:	
U.S. PATENT DOCUMENTS							
EXAMINER INITIALS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
	AL						
	AM						
	AN						
	AO						
	AP						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)							
✓	AQ		D.D. Denton et al., J. Master Res., 1991, 6, 2747				
✓	AR		B.S. Lim et al., J. Polymer Sci., Part B: Polym. Phys., 1993, 31, 545				
✓	AS		S.Z. Li et al., J. Polymer Sci., Part B: Polym. Phys., 1995, 33, 403				
✓	AT		M.T. Bogert and R.R. Renshaw, J.Am. Chem. Sci., 1908, 30, 1135				
✓	AU		T.L. Porter et al., J. Polymer Sci., Part B: Polym. Phys., 1998, 36, 673				
✓	AV		A. Okada et al., Mater. Sci. Eng., 1995, 3, 109				
EXAMINER				DATE CONSIDERED			
<small>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>							